



(社)日本半導体製造装置協会

東京都千代田区六番町 3
番地六番町SKビル6F
Web <http://www.seaj.or.jp>

2007年2月度BBレシオ (Book-to-Bill) (SEAJ速報値) 日本製半導体製造装置 (3ヶ月平均)

注意: データは3ヵ月移動平均です。

次回予定: SEAJ 3月度BBレシオ 4/18 16:00 SEAJ ホームページアップ予定

日本製の半導体製造装置の2007年2月度のBBレシオは1.31

東京 2007年3月19日 - 日本半導体製造装置協会が19日に発表した2月度の半導体製造装置速報値によると日本製装置(輸出を含む)の受注額は**195,575**百万円(3ヶ月移動平均)、BBレシオは**1.31**だった。BBレシオ1.31は100円で販売したのに対し131円の新たな受注があったことを示す。

受注額は前月比**0.1%**増(2007年1月度確定値は**195,368**百万円)、前年同月比**34.5%**増(2006年2月度は**145,389**百万円)の**195,575**百万円だった。

販売額は前月比**0.8%**増(2007年1月度確定値は**148,381**百万円)、前年同月比**17.6%**増(2006年2月度は**127,277**百万円)の**149,632**百万円だった。

※BBレシオの算出に当たっては、受注高、販売高の3ヶ月移動平均データを使用。単位:百万円

	販売 (3ヶ月平均)	受注 (3ヶ月平均)	BBレシオ
2006/9	156,292	168,814	1.08
2006/10	148,972	165,527	1.11
2006/11	145,506	164,465	1.13
2006/12	142,992	168,081	1.18
2007/1(確定値)	148,381	195,368	1.32
2007/2(暫定値)	149,632	195,575	1.31

本データは速報値(3ヶ月移動平均)です。確定値とは多少差異が生じる場合がありますのでご利用に際してはご注意ください。

なおSEMIは北米製の半導体製造装置のBBレシオ(3ヶ月移動平均の受注・販売比率)の速報を公表しています。

Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

お問い合わせ先 : 事務局 広報部長 久野 敏寿(くの としひさ)
Web <http://www.seaj.or.jp> E-mail kuno@seaj.or.jp



February 2007 Book-to-Bill Ratio (Express Report)

Japan-based Semiconductor Manufacturing Equipment (3 Month Average)

Note : All data is based on three month average numbers.

Mark your calendars. **The March Report SEAJ's Web site update** is scheduled on **Wednesday, 18th April** approximately 4:00.P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts **February 2007 Book-to-Bill Ratio of 1.31**

Tokyo Japan., **March 19 2007** -- JAPAN-based manufacturers of semiconductor equipment posted **¥ 195,575 million** in orders in **February 2007** (three-month average basis) and a BB Ratio of **1.31**, according to the **February 2007** BB Ratio published today by SEAJ. A book-to-bill of **1.31** means that **¥ 131** worth of new orders was received for every ¥100 of product billed for the month.

The three-month average of worldwide bookings in **February 2007** was **¥ 195,575 million**. The bookings figure is **0.1 percent up the final January 2007** level of **¥ 195,368 million** and **34.5 percent up the ¥ 145,389 million** in orders posted in **February 2006**.

The three-month average of worldwide billings in **February 2007** was **149,632 million**. The billings figure is **0.8percent up the final January 2007** level of **¥ 148,381 million** and **17.6percent up the February 2006** billings level of **¥ 127,277 million**.

The SEAJ book-to-bill is a ratio of three-month moving average bookings to three-month moving average billings for the Japanese semiconductor equipment industry. Billings and bookings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Bookings (Three-month avg.)	Book-to-Bill
September 2006	156,292	168,814	1.08
October 2006	148,972	165,527	1.11
November 2006	145,506	164,465	1.13
December 2006	142,992	168,081	1.18
January 2007(final)	148,381	195,368	1.32
January 2007(prim)	149,632	195,575	1.31

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Book-to-Bill Ratio published by SEAJ that tracks billings and bookings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings and orders of the chips themselves.

SEMI is released North American Semiconductor Manufacturing Equipment /Book-to-Bill Ratio(3 months Average) on Website. Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

CONTACT : T.KUNO General Manager of Information Department SEAJ

Web <http://www.seaj.or.jp> E-mail kuno@seaj.or.jp